## 長庚大學 電子工程系 大學部必選修科目表 (112學年度入學學生適用)

Curriculum of the Bachelor's program of Dept. Electronic Engineering, Chang Gung University (applicable to students admitted in 2023)

Ī	專業	微積分(Calculus)(1)(2) 普通物理學(1)(2)(General Physics)(1)(2) 普通物理學實驗(General Physics Laboratory)(1)(2) 普通化學(General Chemistry) 普通化學實驗(General Chemistry Laboratory)	3 1 3	3		電路學(二)(Electric Circuits)(2) 電子學(Electronics)(1)(2)	3	-	暑	電磁學(Electromagnetics)(1)(2)	3	_	暑	專題研究(Seminar)(2)	1	1
Compulsory	專業	Physics)(1)(2) 普通物理學實驗(General Physics Laboratory)(1)(2) 普通化學(General Chemistry) 普通化學實驗(General Chemistry Laboratory)	1	+		當子學(Electronics)(1)(2)	$\overline{}$									1
Compulsory	專業	普通物理學實驗(General Physics Laboratory)(1)(2) 普通化學(General Chemistry) 普通化學實驗(General Chemistry Laboratory)	1	+		2 1 4-(Licedonies)(1)(2)	3	3		電子學(Electronics)(3)	3				T	
Compulsory	專業	Laboratory)(1)(2) 普通化學(General Chemistry) 普通化學實驗(General Chemistry Laboratory)	3		-	電子電路實驗(Microelectronic	+	+	$\vdash$	超大型積體電路設計導論	+	├	-		+	-
Compulsory	專業	普通化學實驗(General Chemistry Laboratory)	3	1		Circuit Laboratory)(1)(2)	1	1		(Introduction to VLSI Design)	3					
Compulsory	專業	Laboratory)	1			工程數學(微分方程)(Engineering Math:Partial Differential Equations)	3			電子電路實驗(3)(Microelectronic Circuit Laboratory)(3)	1					
courses	<b>-</b>		1			近代物理(Modern Physics)	3			專題研究(Seminar)(1)	1	1			T	1
Ī		計算機概論(Introduction to		-	-	電子工程概論(Introduction to	13	-	-		+	ŀ,	_		+	-
Ī		Computer Science)	3			Electronic Engineering)		1								
Ī		邏輯設計(Logic Design)	3			半導體元件物理導論 (Semiconductor Device Physics)		3								1
Ī		電路學(一)(Electric Circuits)(1)		3		(Semiconductor Device Physics)	+	-	-		$\vdash$	-	-		+	+
Ī		工程數學(線性代數)(Engineering	Г	3			T								1	1
Ī		Mathematics (Linear Algebra)) 程式設計(Computer Programming)	_	3	-		-	-	-		-	_	_		-	4
Ī		1±2(axa) (Computer Frogramming)	-	3	-		┝	$\vdash$	-	英文口說與報告(1)(2)English	-	-	-		+	+
	院共構課程									Speaking and Presentation(1)(2)	2	2				
						電子學(一)演練(Exercise of Electronics)(1)	1			海外研習(Overseas Study)		1		校外質習(Practice School)	4	I
Nm / 4-	共同選修		-		-	Electronics)(1)		-				-	-	企業實習(1)(2)Industry	6	5
選修 elective														海外研習(Overseas Study)	1	1
courses		創意生醫感測電子實驗(Creative				印刷電路板之系統整合設計暨實		Г		嵌入式系統設計與實作(Design and	Г				Ť	+
	電子智慧	Biomedical Sensing Electronics and Experiments)			3	作(System Integration Design of PCB and Its Implementation)			3	Implementation of Embedded Systems)			4			
	电丁智慧 學程	FPGA實作(FPGA Lab)			3	. CD and its implementation)		-		類比積體電路實作(Analog IC design)			3		-	+
										跨領域實務專題(Interdisciplinary			3		T	+
四大領						訊號與系統(Siginal & System)	-		-	Special Project)  通訊原理(Communication Theory)	-	_	٠	通訊積體電路設計(Design of	-	+
域專業						anomogy resputation and assisting		3		型計原理(Communication Theory)	3			加斯利用通电路或表T(Design of Integrated Circuit for	3	
選修			Y			向量分析與複變函數(Vector		3		數值方法(Numerical Method)		3		被動微波電路設計(Passive	3	T
major			_	$\vdash$	-	Anaysis and Complex Variable) 印刷電路板之系統整合設計暨實		-		通訊電子學(Communication		_		Microwave Ciruit Design) 元件量測與可靠性	1	+
elective						作(System Integration Design of			3	Electronics)		3		Devices Measurement and	3	.
courses				-	_	PCB and Its Implementation)				TRANSPORT OF THE PROPERTY OF T				Reliability		-
										通訊設計實驗(Communication Design Laboratory)		1		電波工程(Electromagnetic Wave Engineering)		
										數位通訊 (Digital Communication)		3		光纖通訊(Optical Fiber		T
7	高頻通訊									工程數學(機率與統計)(Engineering	-	-	-	Communications) 高頻電路設計(High Frequency	┝	+
	電子領域							_ }		Mathematics-Proability and Statistics)		3		Circuit Design)		
	課程									電波工程實驗(Wave Propagation Experiments)		1		微波滤波器設計(Microwave Filter		
	4							$\neg$		A 6 3 10 A 6 A 6 A 6 A 6 A 6 A 6 A 6 A 6 A 6 A	-	$\neg$		Design) 醫療電子臨床導入(Clinical	$\vdash$	+
								_		類比積體電路實作(Analog IC design)		_	_	Application of Medical Electronic	_	1
														生醫植入晶片系統專題(Projects in Imlantable Bio-System-on-a-	3	
													$\overline{}$	天線(Antennas)		
														數位通信積體電路設計(Digital Communication Integrated Circuit		
														Design)		
														數位積體電路設計(Digital		
-		創意生醫感測電子實驗(Creative	+	-	-	資料結構(Data Structure)	-	$\dashv$	$\dashv$	微處理機(Microprocessor)		-	$\rightarrow$	Integrated Circuit Design) 類比積體電路(Analog Integrated		+
		Biomedical Sensing Electronics and			3		3				3			Circuit Design)	3	
		Experiments)	+	+	-	数位系統設計(Digital Circuits and	-	-	-	通訊原理(Communication Theory)		-	-	通訊積體電路設計(Design of	-	+
		FPGA實作(FPGA Lab)			3	Systems)	3			30 (1995) - 1996) - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 - 1996 -	3			Integrated Circuit for Telecommunication)	3	
					- 1	數位系統設計實驗(Digital		1		數位訊號處理(Digital Signal Processing)	3			元件量測與可靠性	3	
			+	+		Circuits and Systems Laboratory) 計算機組織(Computer	-	3		數值方法(Numerical Method)		3		Devices Measurement and 生醫電子學(Biomedical		+
	人工智慧				_	讯號與系統(Siginal & System)		3		積體電路設計實驗(IC Design Lab)		1		DIP設計概論(Advanced DIP		İ
	與晶片系 充領域課					句量分析與複變函數(Vector		3		微處理機實驗(Microprocessor		1		醫療電子臨床導入(Clinical Application of Medical Electronic		
[5]	程		+	$\dashv$	_	Anaysis and Complex Variable) 印刷電路板之系統整合設計暨實	-			Experiments) 工程數學(機率與統計) (Engineering		-	-	数位通信積體電路設計(Digital		+
	-			-	1	F(System Integration Design of				Mathematics- Proability and Statistics)		3		Communication Integrated Circuit		
- 1	-		+	-		CB and Its Implementation)	-	$\dashv$	-	電波工程實驗(Wave Propagation		$\dashv$	_	Design) 數位積體電路設計(Digital	-	+
										电波工程負繳(Wave Propagation Experiments)		1		Integrated Circuit Design)		
						-				嵌入式系統設計與實作(Design and			4			1
	-		4	+	-		-	-	-	Implementation of Embedded Systems)		-			_	+
L			4	1	4			_	_	類比積體電路實作(Analog IC design)		_	3	77-741-77-0	_	1
		創意生醫戲測電子實驗(Creative Biomedical Sensing Electronics and				才料科學導論(Introduction to Material Science)	3			材料結構與特性(Structures and Properties of Materials)	3			量子物理(Quantum Physics)	3	
		Experiments)				12.79 (April 19.10) (April 19.	2				-					1
						固態物理導論(Introduction to	T	3		光電材料(Optical Semiconductor	T	3		材料分析(Material Analysis)		
	H		+	+		folid State Physics) 句量分析與複變的數(Vector	+	3		Materials) 半導體實驗(Semiconductor	1	1	$\dashv$	奈米材料與元件(Nanostructured	3	+

				半導體製程(VLSI Technology)		3	元件量測與可靠性 Devices Measurement and	3	T
奈米材料 製程領域 課程				工程數學(機率與統計)(Engineering Mathematics- Proability and Statistics)		3	非揮發性記憶體元件與製程 (Nonvolatile Memories and Their Fabrication Technologies)		
· 林住				半導體元件設計(Semiconductor Device Design)		3	液晶顯示器薄膜製程技術 (Liquid-Crystal Displays Thin Film Process Technology)		
				電路板基礎工程(Fundamentals and Engineering of Printed Circuit board industry)		3	醫療電子臨床導入(Clinical Application of Medical Electronic Device)	3	
				數值方法(Numerical Method)		3	微機電元件與系統(Micro- electromechanical Device and		1
							太陽能晶片與系統專題(Topics on Solar Cell Chip and System)		1
	材料科學導論(Introduction to Material Science)	3		材料結構與特性(Structures and Properties of Materials)	3		光電實驗(Electro-Optical Laboratory)	1	T
	固態物理導論(Introduction to Solid State Physics)		3	光電材料(Optical Semiconductor Materials)		3	量子物理(Quantum Physics)	3	Ī
			3	半導體製程(VLSI Technology)		3	光學(Optics)	3	T
Ah 44 (17) [7]				半導體實驗(Semiconductor Experiments)	1	1	元件量測與可靠性 Devices Measurement and	3	
綠能照明 領域課程				工程數學(機率與統計)(Engineering Mathematics (Proability and Statistics)		3	基礎群論(Basic Group Theory)		3
				電路板基礎工程(Fundamentals and Engineering of Printed Circuit board industry)		3	材料分析(Material Analysis)		3
				數值方法(Numerical Method)		3	當射物理(Laser Physics)	-510	3
							醫療電子臨床導入(Clinical Application of Medical Electronic	3	
							太陽能晶片與系統專題(Topics on Solar Cell Chip and System)		3

備註 Remark

- 一、I. 1.畢業學分: 129學分。1. Graduation credits: 129 credits
  - (1)必修69學分。(1) 69 credits of compulsory courses
  - (2)選修31學分: (2) 31 credits of elective courses
    - a.系選修至少24學分。a. At least 24 credits of elective courses in the Department of Electronics Engineering (EE).
  - b.選修他系課程至多承認7學分(通識課程、體育及全民國防教育軍事訓練選修課程不予列入)。
  - b. A maximum of 7 credits can be admitted for elective courses from other departments (General education, physical education, and military training elective courses are not included).
  - c.學院共構選修課程列入他系選修。c. The college co-constructed courses are counted as electives of other departments,
  - (3)通識學分:請詳見通識中心修課規定。(3) General Education Credits: Please refer to the course requirements of Center for General Education for details.
  - a.AI領域課程1學分。a. It requires 1 credit for AI courses.
  - b.英文領域、核心、多元課程28學分。 b. 28 credits of English related, core, and diverse courses.
  - 2.體育大一、大二必修0學分。2. It requires 0 credits for compulsory physical education.
  - 3.【深耕學園】必修0學分,請詳見學務處深耕學園專區說明。3. Compulsory "Sprout Campus" 0 credits, please refer to the description of the "Sprout Campus" from Office of Student Affairs for details.
  - 4.本校訂有英文畢業門檻,須達校訂標準方可畢業,請詳見語文中心規定。4. Students must meet the criteria of English Proficiency Assessment before graduation. Please refer to the regulations of the Language Center for details.
- 二、II. 必、選修學分:(常規學期或暑期學制二擇一) Compulsory and elective credits: Can only choose one of the regular or summer academic
  - ◆ 常規學制: 必修69學分、選修31學分(含系選修至少24學分、自由學分至多7學分)、通識29學分 Regular academic system: 69 credits for compulsory courses, 31 credits for elective courses (including at least 24 credits for EE elective courses and at most 7 credits for free elective courses), 29 credits for general education.
  - 1. 必修69學分。69 compulsory credits.
  - 2. 系定專業選修分為四大領域「高頻通訊電子領域」、「人工智慧與晶片系統領域」、「奈米材料製程領域」、「綠能照明領域」 ,系選修必須包含二個專業選修領域(四選二),且每領域至少9學分,**應通過一門選修實驗課**。EE elective courses are divided into four major fields: Group A, Group B, Group C, and Group D. EE elective courses must include two major areas (choose two of the four), and each area must have at least 9 credits and complete one elective experimental courses.
  - 3. 選修他系課程至多承認7學分(通識課程、體育及全民國防教育軍事訓練選修課程不予列人)。 A maximum of 7 credits can be admitted for elective courses from other departments (General education, physical education, and military training elective courses are not included).
  - 4. 企業實習(1)、(2)最多承認為選修學分6學分。"Industry Training" (1) and (2) can be recognized as elective credits at most 6 credits.
  - 5. 暑期學程學分可列為常規學期之專業領域選修學分(含選修實驗課程),「創意生醫鳳測電子實驗」得認列為一門選修實驗課。The credits of the "e-Wise Development Program" can be listed as elective credits (including elective experimental courses) in the major field of the regular semester, and "Creative Biomedical Sensing Electronics and Experiments" can be recognized as an elective experimental course.
  - 6. 學生需先完成海外交換學習歸國後,始可選修本「海外研習」課程。 Students need to complete the overseas exchange study and return to CGU before they can take the "Overseas Study" course.
  - ◆ 暑期學制: 必修68學分、選修32學分(含系定專業選修至少10學分及學程選修15學分、自由學分至多7學分)、通識29學分 Summer academic system: 68 credits for compulsory courses, 32 credits for elective courses (including at least 10 credits for EE elective courses and 15 credits "e-Wise Development Program" elective courses, at most 7 credits for free elective courses), 29 credits for general education.
  - 1. 必修68學分,抵免「專題研究(2)」之替代課程,必須取得下列暑期學程課程學分。Compulsory 68 credits. The credits of the following "e-Wise Development Program" courses are requiredr for the alternative courses of "Seminar (2)".

- (1)「跨領域實務專題」(1) "Interdisciplinary Special Project"
- (2)「嵌入式系統設計與實作」、「類比積體電路實作」(二擇一) (2) "Design and Implementation of Embedded Systems", "Analog IC design" (choose one of the two)
- 2. 糸定專業選修分為四大領域「高頻通訊電子領域」、「人工智慧與晶片系統領域」、「奈米材料製程領域」、「綠能照明領域」,系選修至少需包含一個專業選修領域(四選一),且該領域至少須修滿9學分系選修暨電子智慧學程,應通過一門選修實驗課。EE elective courses are divided into four major fields: Group A, Group B, Group C, and Group D. EE elective courses must include one major areas (choose one of the four), the chosen field must take at least 9 credits of EE electives and "e-Wise Development Program" courses, and complete one elective experimental courses.
- 3. 「電子智慧學程」應修滿15學分。At least 15 credits of "e-Wise Development Program" courses.
- 4. 選修他系課程至多承認7學分(通識課程、體育及全民國防教育軍事訓練選修課程不予列入)。A maximum of 7 credits can be admitted for elective courses from other departments (General education, physical education, and military training elective courses are not included).
- 5.「創意生醫感測電子實驗」得認列為一門選修實驗課。"Creative Biomedical Sensing Electronics and Experiments" is admitted as an elective experimental course.
- 6. 未完成暑期學程者,其暑期學程學分可列為常規學期之專業領域選修學分(含選修實驗課)。For those who have not completed the "e-Wise Development Program", their credits can be admitted as elective credits in the major field of the regular semester (including elective experimental courses).
- 三、III. 擋修課程: Prerequisite courses:
  - 1. 大二「工程數學(微分方程)」先修課程為大一「微積分(2)」達60分。"Calculus (2)" is prerequisite for "Engineering Math: Partial Differential Equations".
  - 2. 大二「數位系統設計」先修課程為大一「邏輯設計」達60分。"Logic Design" is prerequisite for "Digital Circuits and Systems".

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系主任簽章:	16h (14/20	2023.04.20